



## 1N50

Preliminary

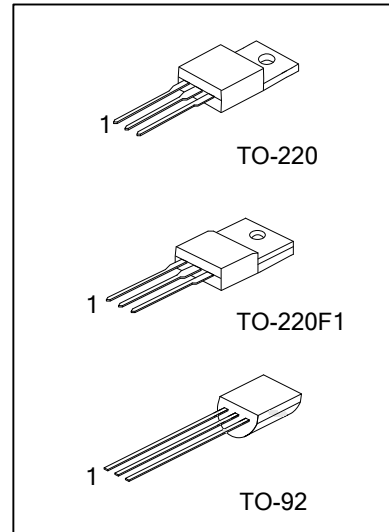
Power MOSFET

### 1.3A, 500V N-CHANNEL POWER MOSFET

#### DESCRIPTION

The UTC **1N50** is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

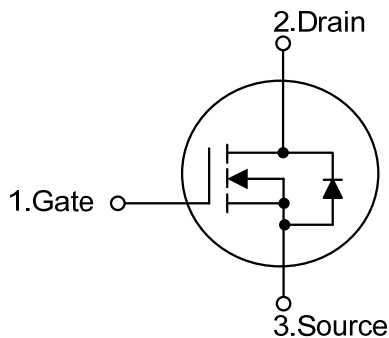
The UTC **1N50** is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.



#### FEATURES

- \*  $R_{DS(ON)}=6.0\Omega @ V_{GS}=10V$
- \* High Switching Speed
- \* 100% Avalanche Tested

#### SYMBOL



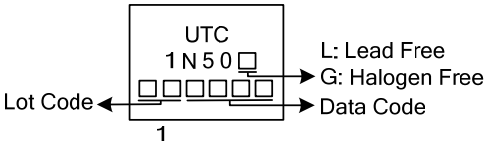
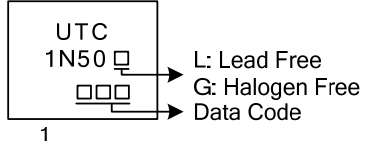
#### ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
1N50L-TA3-T	1N50G-TA3-T	TO-220	G	D	S	Tube
1N50L-TF1-T	1N50G-TF1-T	TO-220F1	G	D	S	Tube
1N50L-92-B	1N50G-T92-B	TO-92	G	D	S	Tape Box
1N50L-92-K	1N50G-T92-K	TO-92	G	D	S	Bulk

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>1N50L-TA3-T</p> <p>(1)Packing Type</p> <p>(2)Package Type</p> <p>(3)Green Package</p>	<p>(1) T: Tube, B: Tape Box, K: Bulk</p> <p>(2) TA3: TO-220, TF1: TO-220F1, T92: TO-92</p> <p>(3) L: Lead Free, G: Halogen Free and Lead Free</p>
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### MARKING

TO-220 / TO-220F1	TO-92
 <p>UTC 1N50</p> <p>Lot Code ← [ ] [ ] [ ] [ ] [ ] → Data Code</p> <p>L: Lead Free G: Halogen Free</p> <p>1</p>	 <p>UTC 1N50</p> <p>[ ] [ ] [ ] → Data Code</p> <p>L: Lead Free G: Halogen Free</p> <p>1</p>

■ ABSOLUTE MAXIMUM RATINGS ( $T_C=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	500	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	Continuous ( $T_C=25^\circ\text{C}$ )	$I_D$	1.3 (Note 2)	A
	Pulsed (Note 3)	$I_{DM}$	5 (Note 2)	A
Avalanche Current (Note 3)		$I_{AR}$	1.3	A
Avalanche Energy	Single Pulsed (Note 4)	$E_{AS}$	113	mJ
	Repetitive (Note 5)	$E_{AR}$	2.6	mJ
Power Dissipation	TO-220	$P_D$	40	W
	TO-220F1		20	W
	TO-92		1.56	W
Derate above $25^\circ\text{C}$	TO-220		0.32	W/ $^\circ\text{C}$
	TO-220F1		0.16	W/ $^\circ\text{C}$
	TO-92		0.0125	W/ $^\circ\text{C}$
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Drain current limited by maximum junction temperature
3. Repetitive Rating: Pulse width limited by maximum junction temperature
4.  $L = 120\text{mH}$ ,  $I_{AS} = 1.3\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 27\Omega$ , Starting  $T_J = 25^\circ\text{C}$
5.  $I_{SD} \leq 1.5\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F1	$\theta_{JA}$	62.5	$^\circ\text{C}/\text{W}$
	TO-92		180	$^\circ\text{C}/\text{W}$
Junction to Case	TO-220	$\theta_{JC}$	3.13	$^\circ\text{C}/\text{W}$
	TO-220F1		6.24	$^\circ\text{C}/\text{W}$
	TO-92		80	$^\circ\text{C}/\text{W}$

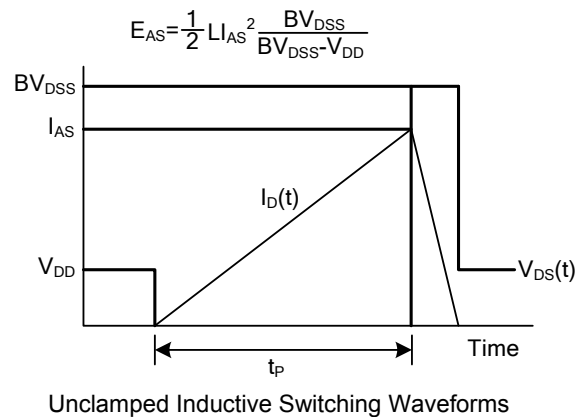
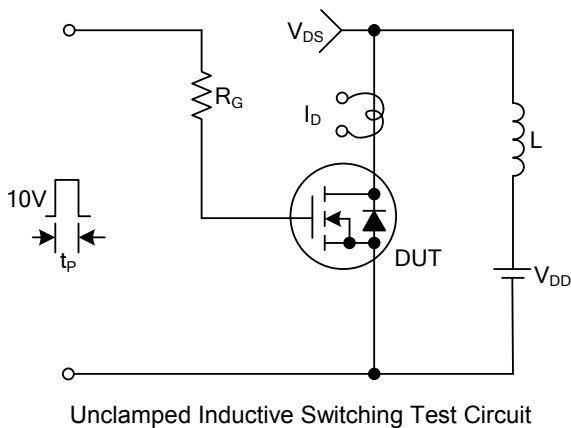
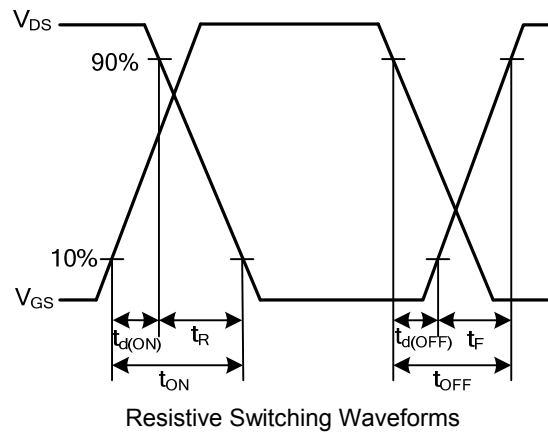
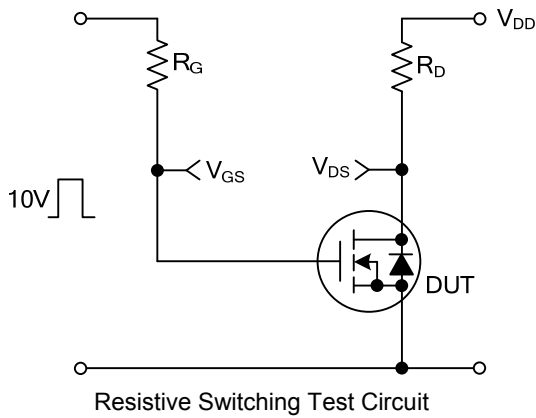
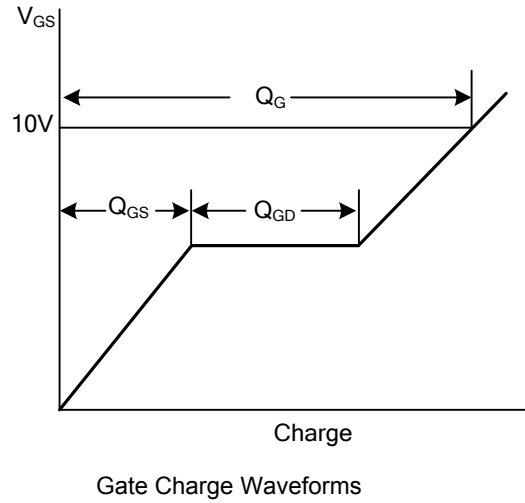
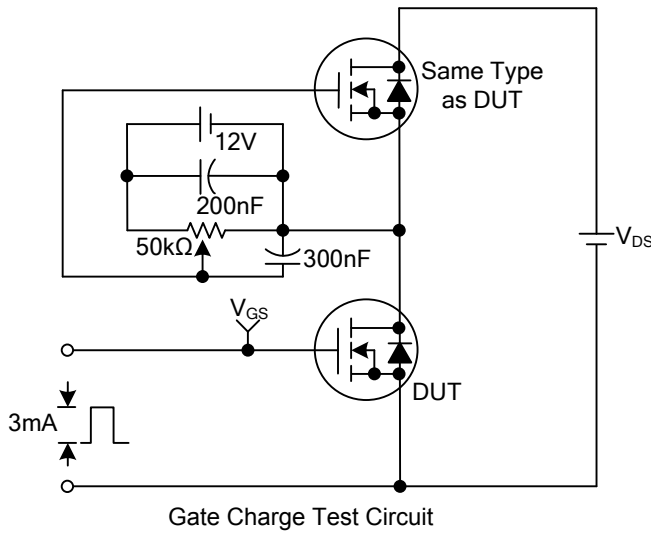
■ ELECTRICAL CHARACTERISTICS ( $T_c=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D=250\mu\text{A}$ , $V_{GS}=0\text{V}$	500			V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=500\text{V}$ , $V_{GS}=0\text{V}$			1	$\mu\text{A}$
Gate- Source Leakage Current	Forward	$V_{GS}=+30\text{V}$ , $V_{DS}=0\text{V}$			+100	nA
	Reverse	$V_{GS}=-30\text{V}$ , $V_{DS}=0\text{V}$			-100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10\text{V}$ , $I_D=0.65\text{A}$		4.3	6.0	$\Omega$
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	$C_{ISS}$	$V_{GS}=0\text{V}$ , $V_{DS}=25\text{V}$ , $f=1.0\text{MHz}$		220	290	pF
Output Capacitance	$C_{OSS}$			30	35	pF
Reverse Transfer Capacitance	$C_{RSS}$			11	13	pF
<b>SWITCHING PARAMETERS</b>						
Turn-ON Delay Time	$t_{D(ON)}$	$V_{DD}=30\text{V}$ , $I_D=0.5\text{A}$ , $R_G=25\Omega$ (Note 1, 2)		44	50	ns
Rise Time	$t_R$			31	35	ns
Turn-OFF Delay Time	$t_{D(OFF)}$			58	90	ns
Fall-Time	$t_F$			22	40	ns
Total Gate Charge	$Q_G$	$V_{GS}=10\text{V}$ , $V_{DS}=50\text{V}$ , $I_D=1.3\text{A}$ (Note 1, 2)		11	16	nC
Gate to Source Charge	$Q_{GS}$			3.64		nC
Gate to Drain Charge	$Q_{GD}$			2		nC
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Continuous Current	$I_S$				1.3	A
Maximum Body-Diode Pulsed Current	$I_{SM}$				5	A
Drain-Source Diode Forward Voltage	$V_{SD}$	$I_S=1.3\text{A}$ , $V_{GS}=0\text{V}$			1.15	V

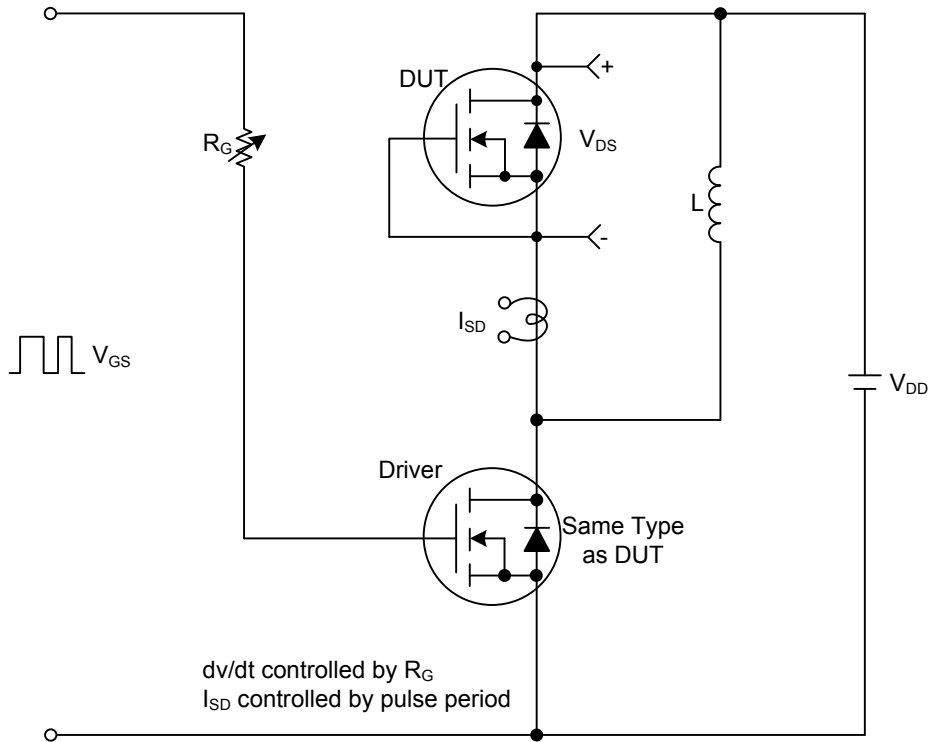
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$

2. Essentially independent of operating temperature

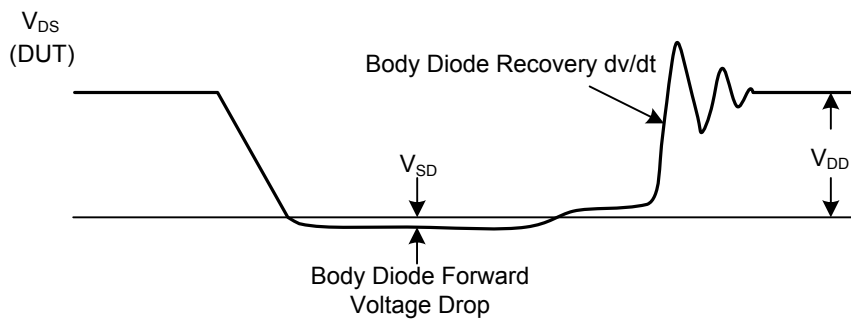
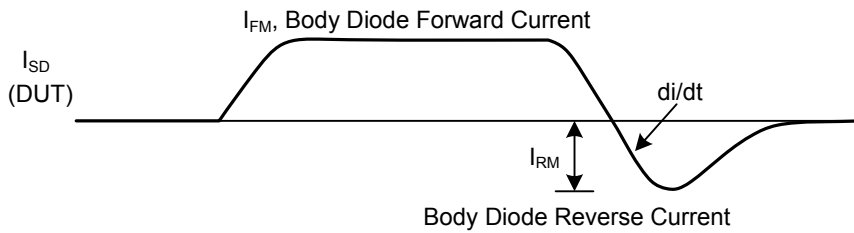
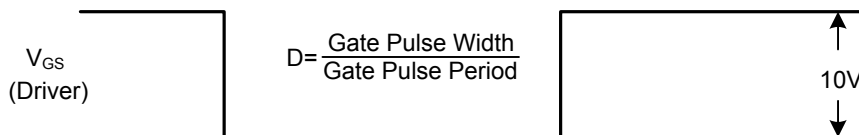
■ TEST CIRCUITS AND WAVEFORMS



■ TEST CIRCUITS AND WAVEFORMS(Cont.)



Peak Diode Recovery dv/dt Test Circuit & Waveforms



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